

J220S-VB Datasheet

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ)			
- 60	0.064 at V _{GS} = - 10 V	- 30	12			
- 00	0.077 at V _{GS} = - 4.5 V	- 28	12			

FEATURES

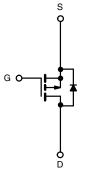
- Trench Power MOSFET100
- % UIS Tested

APPLICATIONS

Load Switch







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_{C} = 25$	5 °C, unless othe	rwise noted		
Parameter	Symbol	Limit	Unit	
Gate-Source Voltage	V _{GS}	± 20	V	
Continuous Drain Current ($T_1 = 175 \ ^{\circ}C$)	T _C = 25 °C	1_	- 30	
Continuous Drain Current $(1) = 175$ C)	T _C = 100 °C		- 20	
Pulsed Drain Current	I _{DM}	- 90	А	
Continuing Source Current (Diode Conduction)	۱ _S	- 28		
Avalanche Current	I _{AS}	- 31		
Single Pulse Avalanche Energy	E _{AS}	7.2	mJ	
Maximum Dawar Discinction	T _C = 25 °C	Р	60 ^a	w
Maximum Power Dissipation	T _A = 25 °C	P _D	6 ^b	v
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
hunding to Ambient	$t \le 10 \text{ sec}$	R _{thJA}	20	25	°C/W	
Junction-to-Ambient ^D	Steady State	' 'thJA	62	75		
Junction-to-Case		R _{thJC}	5	6		

Notes:

a. See SOA curve for voltage derating.

b. Surface Mounted on 1" x 1" FR-4 boad.

SPECIFICATIONS $T_J = 25$	°C, unless	otherwise noted					
Parameter	Symbol	Test Conditions	Min	Тур ^а	Max	Unit	
Static	•			•			
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0	- 2.0	- 3.0	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μΑ	
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			- 150		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 10			А	
		V _{GS} = - 10 V, I _D = - 5 A		0.064			
	r	V_{GS} = - 10 V, I _D = - 5 A, T _J = 125 °C		0.110		Ω	
Drain-Source On-State Resistance ^b	r _{DS(on)}	V_{GS} = - 10 V, I _D = - 5 A, T _J = 175 °C		0.250			
		V _{GS} = - 4.5 V, I _D = - 2 A		0.077			
Forward Transconductanceb	9 _{fs}	V _{DS} = - 15 V, I _D = - 5 A		8		S	
Dynamic		•		•			
Input Capacitance	C _{iss}			1000		pF	
Output Capacitance	C _{oss}	$V_{DS} = -25 V$, $V_{GS} = 0 V$, f = 1 MHz		210			
Reverse Transfer Capacitance	C _{rss}			110			
Total Gate Charge	Qg			12.5	19	nC	
Gate-Source Charge	Q _{gs}	V_{DS} = - 30 V, V_{GS} = - 10 V, I_{D} = - 8.4 A		2.3			
Gate-Drain Charge	Q _{gd}			3.2		1	
Gate Resistance	R _g	f = 1 MHz		8.0		Ω	
Turn-On Delay Time ^c	t _{d(on)}			5	10		
Rise Time ^c	t _r	V_{DD} = - 30 V, R_L = 3.57 Ω		14	25		
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_{\text{D}}\cong$ - 8.4 A, V_{GEN} = - 10 V, R_{G} = 2.5 Ω		15	25	ns	
Fall Time ^c	t _f]		7	12	1	
Source-Drain Diode Ratings and Cha	racteristics	$(T_C = 25 \ ^{\circ}C)^b$					
Pulsed Current	I _{SM}				- 30	А	
Forward Voltage ^b	V _{SD}	I _F = - 2 A, V _{GS} = 0 V		- 0.9	- 1.3	V	
Reverse Recovery Time	t _{rr}	I _F = - 8 A, di/dt = 100 A/μs		50	80	ns	
Reverse Recovery Time	Q _{rr}	$F = -0 A$, $u/ut = 100 A/\mu S$		80	120	nC	

Notes:

a. Guaranteed by design, not subject to production testing.

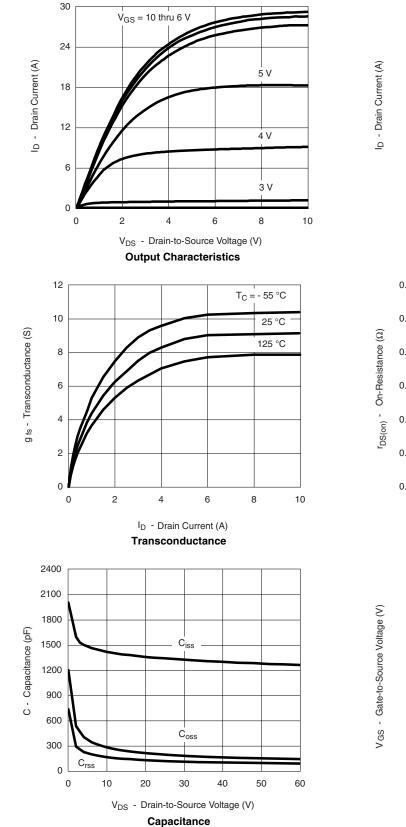
b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

c. Independent of operating temperature.

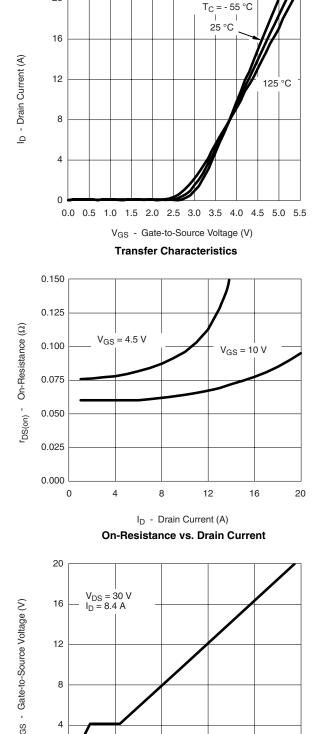
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

VBsemi VBsemi.com

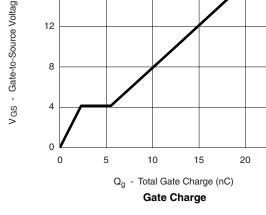




TYPICAL CHARACTERISTICS 25 °C unless noted



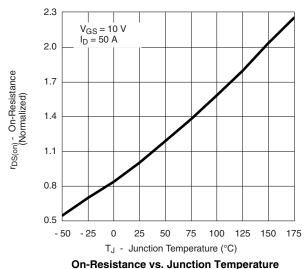
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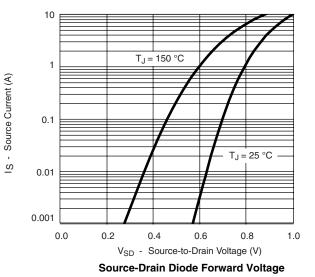


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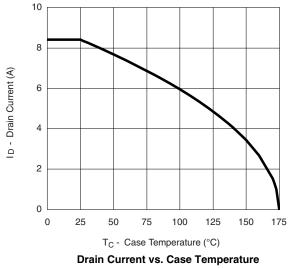


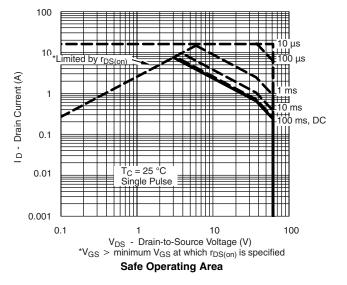
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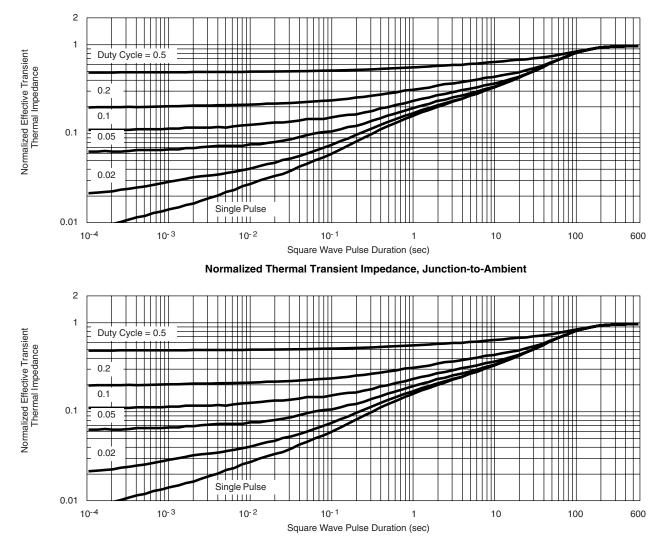








THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case

J220S-VB



H

B

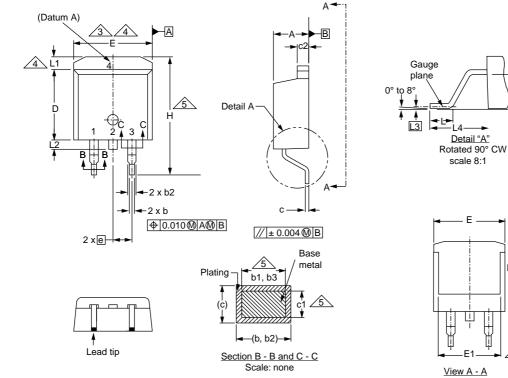
A1

 $D_1 4$

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Seating plane

TO-263AB



	MILLIMETERS		INCHES			MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MAX
А	4.06	4.83	0.160	0.190	D1	6.86	-	0.270	-
A1	0.00	0.25	0.000	0.010	E	9.65	10.67	0.380	0.42
b	0.51	0.99	0.020	0.039	E1	6.22	-	0.245	-
b1	0.51	0.89	0.020	0.035	е	2.54 BSC		0.100 BSC	
b2	1.14	1.78	0.045	0.070	Н	14.61	15.88	0.575	0.62
b3	1.14	1.73	0.045	0.068	L	1.78	2.79	0.070	0.11
С	0.38	0.74	0.015	0.029	L1	-	1.65	-	0.06
c1	0.38	0.58	0.015	0.023	L2	-	1.78	-	0.07
c2	1.14	1.65	0.045	0.065	L3	0.25 BSC		0.010 BSC	
D	8.38	9.65	0.330	0.380	L4	4.78	5.28	0.188	0.20

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

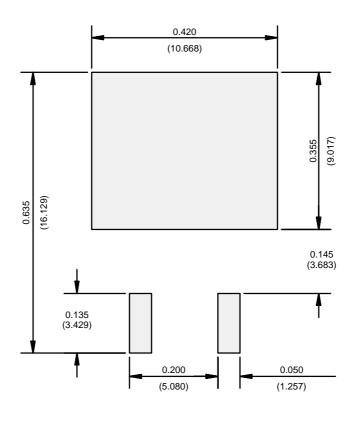
5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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